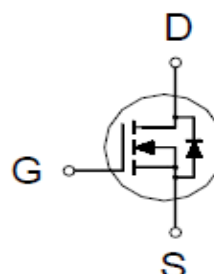


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PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D^3
20V	5mΩ @ $V_{GS} = 4.5V$	47A



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	20	V
Gate-Source Voltage		V_{GS}	±8	
Continuous Drain Current ³	$T_c = 25\text{ }^{\circ}\text{C}$	I_D	47	A
	$T_c = 100\text{ }^{\circ}\text{C}$		30	
	$T_A = 25\text{ }^{\circ}\text{C}$		15	
	$T_A = 70\text{ }^{\circ}\text{C}$		12	
Pulsed Drain Current ¹		I_{DM}	70	
Avalanche Current		I_{AS}	38.6	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	74.6	mJ
Power Dissipation	$T_c = 25\text{ }^{\circ}\text{C}$	P_D	19	W
	$T_c = 100\text{ }^{\circ}\text{C}$		7	
	$T_A = 25\text{ }^{\circ}\text{C}$		2	
	$T_A = 70\text{ }^{\circ}\text{C}$		1.3	
Operating Junction & Storage Temperature Range		T_J, T_{stg}	-55 to 150	$^{\circ}\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$R_{\theta JA}$		60	$^{\circ}\text{C} / \text{W}$
Junction-to-Case	$R_{\theta JC}$		6.5	

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^{\circ}\text{C}$.

³Package limitation current is 22A.

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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	20			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.4	0.7	0.9	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 8V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 16V, V_{GS} = 0V$			1	μA
		$V_{DS} = 10V, V_{GS} = 0V, T_J = 55\text{ }^{\circ}C$			10	
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 4.5V, I_D = 5A$		4.1	5	m Ω
		$V_{GS} = 2.5V, I_D = 5A$		4.7	5.7	
		$V_{GS} = 1.8V, I_D = 5A$		6	8.2	
Forward Transconductance ¹	g_{fs}	$V_{DS} = 5V, I_D = 5A$		70		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 10V, f = 1MHz$		4407		pF
Output Capacitance	C_{oss}			469		
Reverse Transfer Capacitance	C_{rss}			381		
Gate Resistance	R_g	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$		0.7		Ω
Total Gate Charge ²	Q_g	$V_{GS}=4.5V, V_{DS} = 10V, I_D = 5A$		49		nC
Gate-Source Charge ²	Q_{gs}			6		
Gate-Drain Charge ²	Q_{gd}			13		
Turn-On Delay Time ²	$t_{d(on)}$	$V_{DD}= 4.5V, I_D \cong 5A,$ $V_{GEN} = 10V, R_G= 6\Omega$		20		nS
Rise Time ²	t_r			25		
Turn-Off Delay Time ²	$t_{d(off)}$			180		
Fall Time ²	t_f			85		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T _J = 25 °C)						
Continuous Current ³	I _S				14	A
Forward Voltage ¹	V _{SD}	I _F = 5A, V _{GS} = 0V			1.3	V
Reverse Recovery Time	t _{rr}	I _F = 5A, dI _F /dt = 100A / μ S		24		nS
Reverse Recovery Charge	Q _{rr}			12		nC

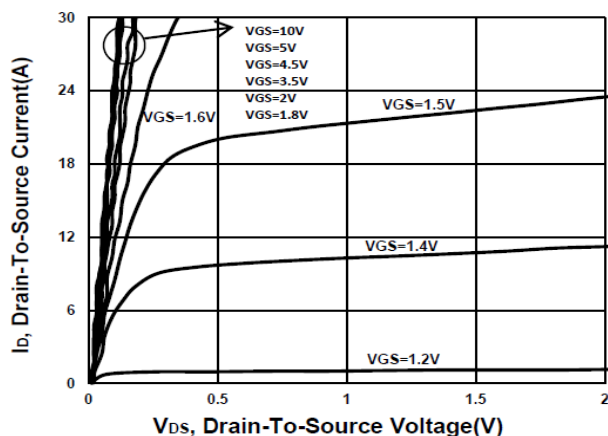
¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

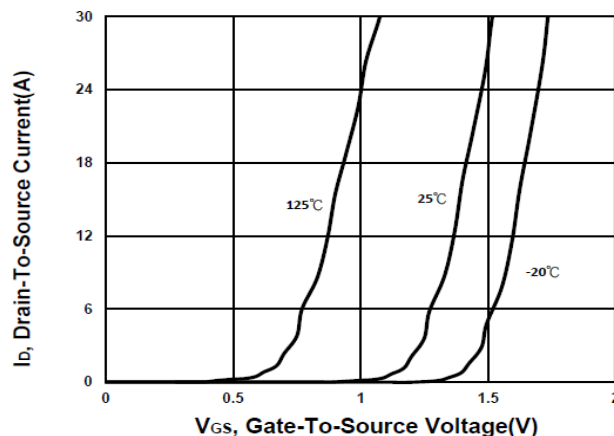
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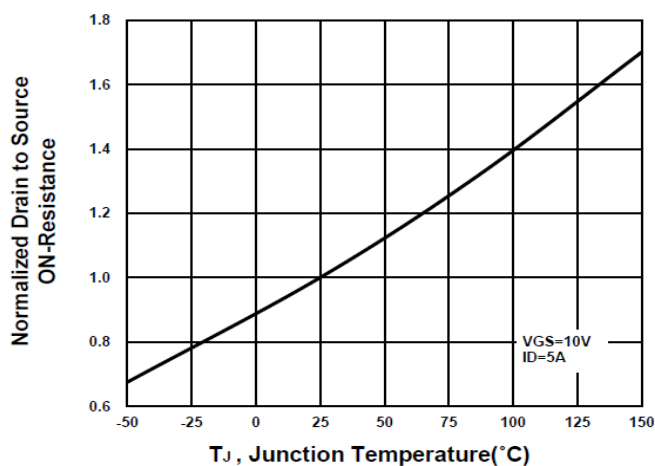
Output Characteristics



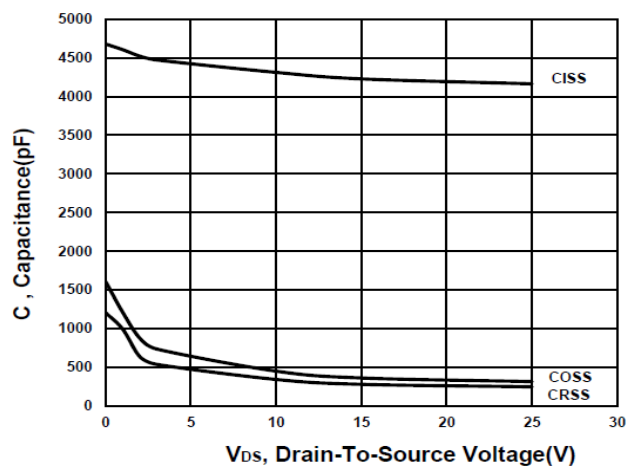
Transfer Characteristics



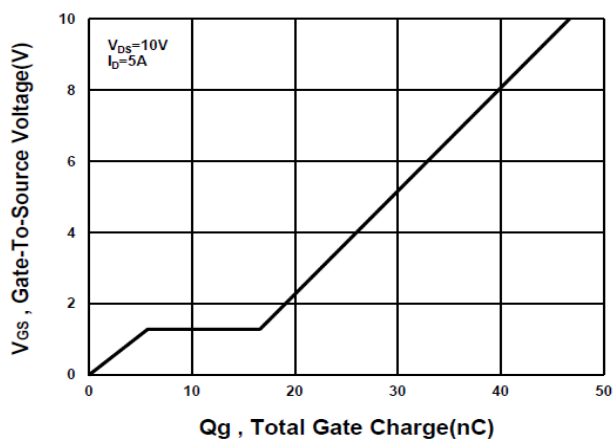
On-Resistance VS Temperature



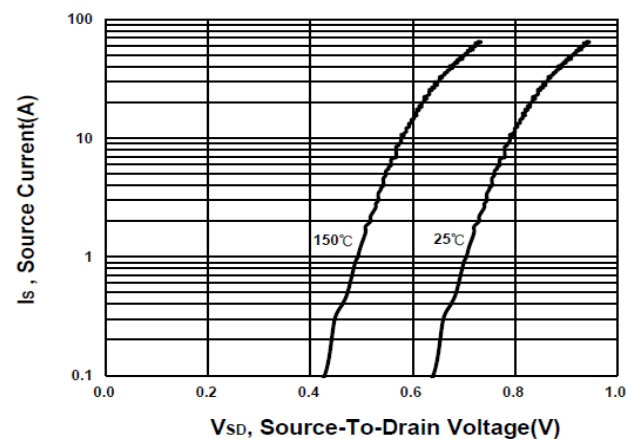
Capacitance Characteristic



Gate charge Characteristics



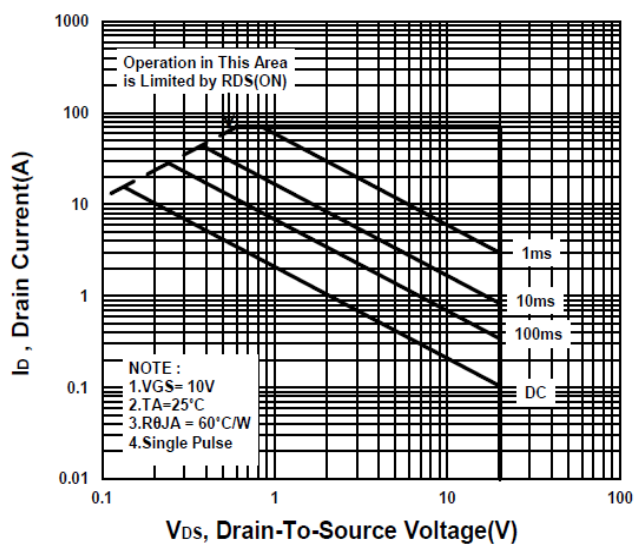
Source-Drain Diode Forward Voltage



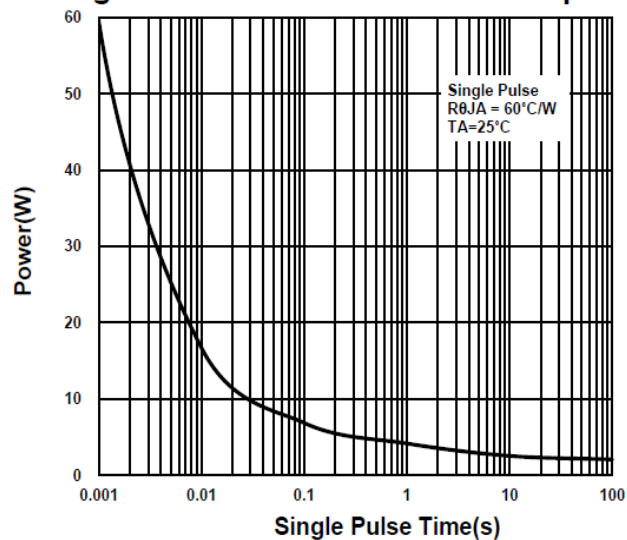
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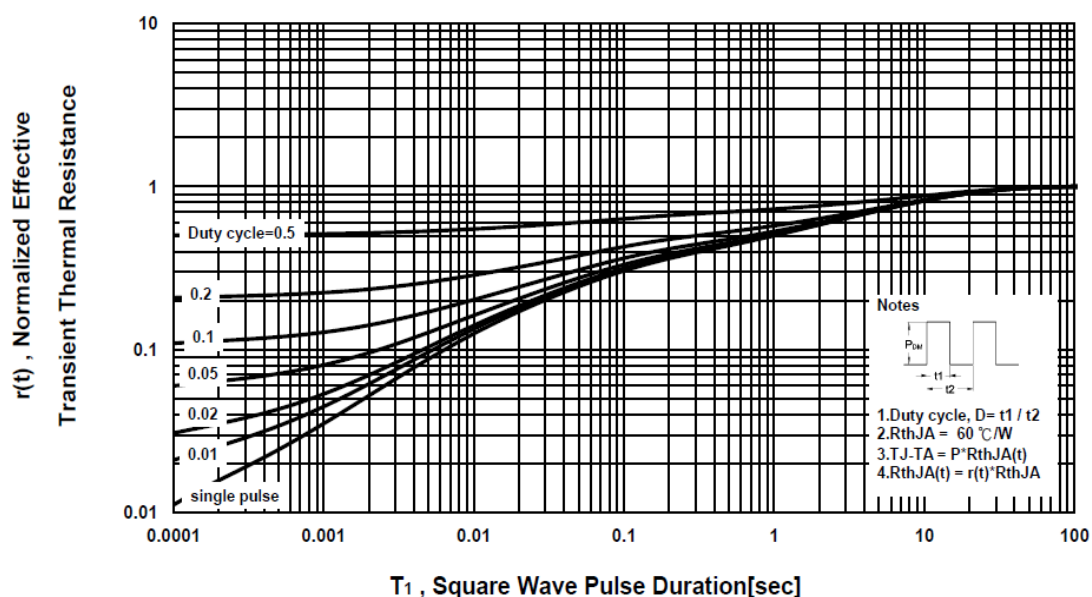
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



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Package Dimension

PDFN 3x3P MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	3		3.6	I	0.7		1.12
B	2.88		3.2	J	0.1		0.33
C	2.9		3.2	K	0.6		
D	1.98		2.69	L	0°	10°	12°
E	3		3.6	M	0.14		0.41
F	0		0.455	N	0.6		0.7
G	1.47		2.2	O	0.12		0.36
H	0.15		0.56	P	0		0.2

